

**REMARKS**

Claims 1-17 are pending in the above-identified application. Claims 1-10 were rejected. With this amendment, claims 1-10 were amended and new claims 11-17 were added. With this amendment, the words "wafer" and "device" were substituted with the words "substrate" and "element." Applicant maintains that no new matter has been added with this amendment. Accordingly, claims 1-10 are at issue in the above-identification application.

Applicants would like to thank Examiner Donghai D. Nguyen for his helpful and courteous discussion held with Applicants' representative on October 15, 2003. During the interview the invention and a proposed amendment to clearly define the claimed invention was discussed.

In the Office Action mailed May 9, 2003, the Examiner has pointed out that the listing of references in the specification was not a proper information disclosure statement. The specification has been reviewed and all references have been properly listed in an information disclosure statement submitted with this response.

FIGS. 11A and 11B of the drawings were objected to for not having a legend. Pursuant to 37 C.F.R. § 1.121(d), enclosed is a copy of Figures 11A and 11B with red ink markings showing proposed changes thereto for which approval of the Examiner is requested. The proposed changes add the legend --Prior Art--. The proposed changes are to correct the drawing and do not constitute new matter.

The title of the invention was objected to for not being descriptive. Applicant has amended to title so as to be more descriptive.

Claims 1-9 were rejected under 35 U.S.C. §112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which Applicants regard as

the invention. Applicant has amended claims 1-9 in response. It is submitted that this rejection has been overcome.

Claims 1-10 were rejected under 35 U.S.C. § 102(b) as being anticipated by Sadamasa et al. (U.S. Patent No. 4,465,543).

Amended claim 1 recites a method for mounting a plurality of elements comprising separating a plurality of elements, which have been arrayed at a first period on a substrate, into individual elements while keeping the first period as it is, wherein more than one but not all of the elements in a given row are separated from the substrate. Amended claim 10 recites a method comprising transferring a plurality of elements, which have been arrayed on a substrate at initial intervals, on a mounting board, wherein the elements are discretely mounted on the mounting board in such a manner as to be two-dimensionally re-arrayed at intervals greater than their initial intervals.

Sadamasa et al. fails to fairly teach or suggest this method. In contrast, Sadamasa et al. teaches simultaneously transposing all of the pellets in a given row all at once, instead of not all of the elements in a given row. Additionally, Sadamasa et al. teaches transferring a one-dimensional row of pellets and not a two-dimensional array of elements. Accordingly, Sadamasa et al. does not suggest or teach a element as claimed in claims 1-10.

**CONCLUSION**

In view of the remarks set forth above, Applicant respectfully submits that the present invention is in condition for allowance. Early notification to such effect is earnestly solicited. Should the Examiner have any remaining issue, Applicant kindly requests that the Examiner contact the undersigned.

Respectfully submitted,



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